

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	("(((solidadjstate)semiconductormetalgate) near(layerfilmmaterial))with(nonearmore near40.0nearangstrom\$1)").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/03/21 13:39
L2	0	(((solid adj state) semiconductor metal gate) near (layer film material)) with (no near more near "40.0" near angstrom\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:41
L3	0	(((solid adj state) semiconductor metal gate) near (layer film material)) with ("40.0" near angstrom\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:40
L4	0	(((solid adj state) semiconductor metal gate) near (layer film material)) and (no near more near "40.0" near angstrom\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:41
L5	646122	(((solid adj state) semiconductor metal gate) near (layer film material))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:41
L6	0	((no near more) leass) near "40.0" near angstrom\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:42
L7	0	((no near more) less) near "40.0" near angstrom\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:42
L8	6	"40.0" near angstrom\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:43

L9	2356	"40" near angstrom\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:43
L10	993	5 and 9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:44
L11	4	10 and (metallurgical\$2 near bond\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:56
L12	12	("20020164846"   "3430109"   "3585714"   "4371406"   "4916513"   "4946800"   "5082793"   "5696402"   "6057584"   "6599781").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/21 13:48
L13	1	10 and (atomic\$4 near smooth near surface)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:56
L14	1	9 and (atomic\$4 near smooth near surface)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:58
L15	6	9 and (metallurgical\$2 near bond\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:57
L16	18	9 and (atomic\$4 near smooth)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/03/21 13:58
L17	2	("5422305"   "5606177").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/21 14:09